Electronic Patent Application Fee Transmittal								
Application Number:	10562236							
Filing Date:	07-Feb-2007							
Title of Invention:	Manufacturing method of silicon wafer							
First Named Inventor/Applicant Name:	Sakae Koyata							
Filer:	Stephen M. Roylance/Liping Qi							
Attorney Docket Number:	JG-SU-5222/500577.20072							
Filed as Large Entity								
U.S. National Stage under 35 USC 371 Filing	Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:			'					
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:					*			
Patent-Appeals-and-Interference:					V I			
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Submission-Information Disclosure Stmt	1806	1	180	180				
	Tot	180						